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| **AUTHOR:** | **CHECKED:** | **DATE** | **APPROVALS** |
| **DCN NO.**  | **REV** | **DATE** |
| **E. Hirose** |  | **Nov21-11** |  | **V1** | **Nov21-11** |
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**Applicable Documents**

LCGT-MIR-D00001-V1 Sapphire Substrate, LCGT Input Test Mass
LCGT-XXXXX-ASapphire Blank, Input Test Mass
LCGT-XXXXX-A Sapphire Blank, Input Test Mass

**Requirements**

**Physical Configuration**

According to LCGT-MIR-D00001-V1 Sapphire Substrate, LCGT Input Test Mass

**Fabricate from**

LCGT-XXXXX- A Sapphire Blank, Input Test Mass
LCGT-XXXXX- A Sapphire Blank, Input Test Mass

## Registration Marks

Registration marks shall be etched, ground or sandblasted and located per LCGT-MIR-D00001-V1

## Side and Bevel Polish

All surfaces, including Sides and Bevels shall be polished using a progression of smaller grit sizes. The last step before final polish shall be equal to or less than a five micrometer grit finish. These surfaces shall appear transparent with no grey, scuffs or scratches visible to the naked eye when viewed in normal room light against a black background.

**Bevel**

Bevel for safety per LCGT-MIR-D00001-V1

## Serial Number

Serial Number “ITM YY” shall be shall be etched, ground or sandblasted on the barrel of the optic per LCGT-MIR-D00001-V1, where Y is incremental starting with 01.

**Scratches, Sleeks and Point defects**

Point defects of radius greater than 25 micrometers are treated like scratches for the purpose of this specification.

**Scratches and Sleeks, Surface 1**

The total area of scratches and sleeks within the central 100 mm diameter shall not exceed 20 X 103 square micrometers (width times length.)

The total area of scratches and sleeks outside the central 100 mm diameter shall not exceed 300 X 103 square micrometers (width times length.)

**Scratches and Sleeks, Surface 2**

The total area of scratches and sleeks within the central 100 mm diameter shall not exceed 250 X 103 square micrometers (width times length.)

**Point Defects, Surface 1**

There shall be no more than 10 point defects of radius greater than 2 m within the central 100 mm diameter. There shall be no more than 100 point defects of radius greater than 2 m on the entire surface, inspected out to 210mm diameter. Average density of defects less than 2m radius must be less than or equal to 1 per 4mm2

**Point Defects, Surface 2**

There shall be no more than 100 point defects of radius greater than 2 m within the central 100 mm diameter

**Scratch and Point Defect Inspection Method**

1. The surface is examined visually by two observers independently. The examination is done against a dark background using a fiber optic illumination system of at least 200 W total power. A 100% inspection of the surface is carried out. Pits and scratches down to 2 micrometers in width can be detected using this method of inspection. Any scratches or sleeks that are detected will be measured using a calibrated eyepiece.

2. Further inspection will be done with a minimum 6X eyeglass using the same illumination conditions, again with two observers. Sleeks down to 0.5 micrometers wide can be detected using this method. The surface will be scanned along one or two chords from centre to edge, then at ten positions around the edge, and ten to fifteen positions near the centre.

3. An inspection is then carried out with a dark or bright field microscope, with 5x objective at four positions at each of the following locations:

1. Within 10mm of the center of the surface.
2. Equally spaced along the circumference of a centered, 60 mm diameter circle.
3. Equally spaced along the circumference of a centered, 120 mm diameter circle.

**Optical Surface Figure, measured over the central 160 mm diameter**

**Surface 1:** Spherical, concave. Radius of curvature: 1680 m -8.4, +8.4 m absolute accuracy
ROC precision: R ± 3 m where 1671.6 m ≤ R ≤ 1688.4 m for both ITM optics
Astigmatism: < 3 nm Amplitude of the Zernike coefficient Z2, 2 as defined in Born and Wolf pp. 523-525.

**Surface 2:** Nominally flat. Curvature of the transmitted reflected wavefront off of Surface 1 as measured through Surface 2 must be within ± 10m of the calculated curvature accounting for the bulk of the material.  The calculated curvature is based on the Surface 1 measurement and ideal homogeneous index of refraction.

**Surface Error, Low Spatial Frequency: measurement aperture to 1 mm-1**

The following root mean square standard deviation (σrms) values are calculated from the phase maps which are to be provided with each optic. For this calculation the amplitudes for the best fit Zernike terms Z0,0, Z1,1, Z2,0 and Z2,2 or corresponding Seidel aberrations are subtracted from the phase map. Known bad pixels may be excluded from this calculation.

Surface 1, Frequency Band: < 1 mm -1Measured outside the central 140 mm diameter aperture: σrms < 2.0nanometers
Measured over the central 140 mm diameter aperture: σrms < 0.5 nanometers

Surface 2 - Frequency Band: < 1 mm -1Measured outside the central 140 mm diameter aperture: σrms < 4 nanometers
Measured over the central 140 mm diameter aperture: σrms < 2 nanometers

**Error, High Spatial Frequency: 1– 750 mm -1**

Surface 1 HSF error σrm**s** < 0.16 nanometers measured at the following locations:
1. Within 2mm of the center of the surface.
2. Four positions equally spaced along the circumference of a centered, 60 mm diameter circle.
3. Three positions equally spaced along the circumference of a centered, 120 mm diameter circle.

Surface 2 HSF error σrm**s** < 0.5 nanometer measured at the following location:
1. Within 2mm of the center of the surface.
2. Four positions equally spaced along the circumference of a centered, 60 mm diameter circle.
3. Three positions equally spaced along the circumference of a centered, 120 mm diameter circle.

## Mounting Flat Figure, measured over the Bond Area described in DXXXXX-v1, 2 places

Flatness: Peak to valley maximum deviation over the bond area, with tilt subtracted: < 60 nm
In the frequency band < 0.5 mm-1,σrms < 20 nm

**Inspection**

1. **Table 1: Inspections**

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| Specification  | Test Method and frequency | Data Delivered  |
| Dimensions | Measurement100%  | Measurement Results |
| Scratches and Point defects methods 1 and 2  | Visual Inspection100%  | Hand sketch including scratch/pit dimensions  |
| Scratches and Point defects method 3 | Visual Inspection100% | Digital image of each inspection location |
| Figure | Interferometry 100% | Surface phase maps  |
| Errors - Low Spatial Frequency  | Interferometry 100% | Surface phase maps |
| Errors - High Spatial Frequency  | Interferometry 100% | Surface maps for 3 central locations. Numerical values included with certification  |
| Mounting Flat figure | Interferometry100% | Surface phase map  |

Orientation: For the purpose of full surface phase maps the data shall be oriented such that the substrate registration mark is at the top center of the data.

Format: All Data shall be delivered according to Table 1. In addition to the hard copy, an electronic data set of the phase maps shall be delivered in ASCII format.